COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE | BOARD #: PMP20637 | REV: A | SUN REV: Not In VersionControl
---|---|---|---
TID #: N/A

PLOT NAME = Top Assembly Drawing | GENERATED : 5/11/2017 5:03:02 PM | TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: PMP20637</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
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PLOT NAME = Bottom Assembly Drawing

GENERATED: 5/11/2017 5:03:04 PM

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